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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

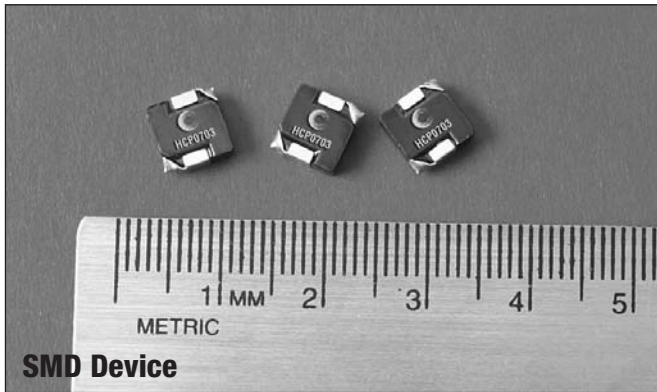
Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



# High Current, Pressed, Power Inductors

## HCP0703 Series



SMD Device

### Description

- 125°C maximum total temperature operation
- 7.0 x 7.3 x 3.0mm surface mount package
- Magnetically shielded, low EMI
- Pressed powder iron core material
- Enhanced core coating eliminates rusting and provides high insulation impedance
- Inductance range from 0.15µH to 10.0µH
- Current range from 52.0 Amps to 3.0 Amps
- Frequency range up to 1MHz
- Black or gray aesthetic color

### Applications

- Notebook power
- VRM, multi-phase buck regulator
- DC-DC converters
- PC workstations/Servers/Desktop
- Routers



### Environmental Data

- Storage temperature range: -55°C to +125°C
- Operating temperature range: -55°C to +125°C (range is application specific)
- Solder reflow temperature: +260°C max. for 10 seconds maximum

### Packaging

- Supplied in tape and reel packaging, 1500 parts per reel, 13" diameter reel

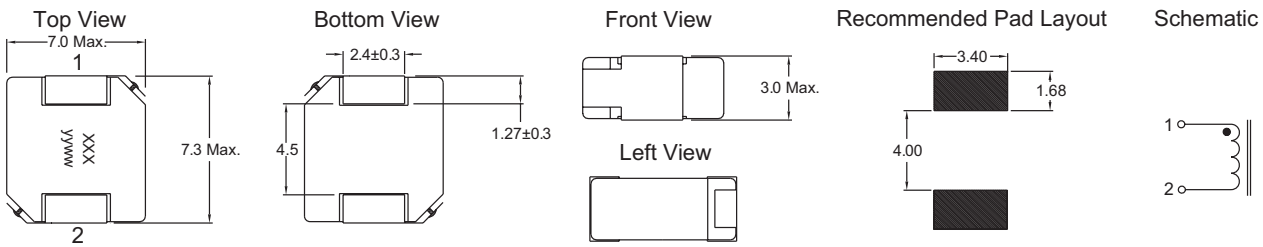
### Product Specifications

Part Number <sup>5</sup>	Rated Inductance (µH)	OCL <sup>1</sup> µH ± 20%	I <sub>rms</sub> <sup>2</sup> Amps	I <sub>sat</sub> <sup>3</sup> Amps	DCR mΩ@20°C (Typical)	DCR mΩ@20°C (Maximum)	K-factor <sup>4</sup>
HCP0703-R15-R	0.15	0.15	26	52	1.9	2.5	1100
HCP0703-R22-R	0.22	0.22	23	40	2.5	2.8	922
HCP0703-R47-R	0.47	0.47	17	26	4.0	4.2	559
HCP0703-R68-R	0.68	0.68	15	25	5.0	5.5	435
HCP0703-R82-R	0.82	0.82	13	24	6.8	8.0	360
HCP0703-1R0-R	1.0	1.0	11	22	9.0	10	356
HCP0703-1R5-R	1.5	1.5	9	18	14	15	307
HCP0703-2R2-R	2.2	2.2	8	14	18	20	206
HCP0703-3R3-R	3.3	3.3	6	13.5	28	30	186
HCP0703-4R7-R	4.7	4.7	5.5	10	37	40	171
HCP0703-6R8-R	6.8	6.8	4.5	8	54	60	140
HCP0703-8R2-R	8.2	8.2	4	7.5	64	68	132
HCP0703-100-R	10.0	10.0	3	7.0	102	105	112

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.25V, 0.0Adc  
 2 I<sub>rms</sub>: DC current for an approximate ΔT rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow and proximity of other heat generating components will affect the temperature rise. It is recommended the part temperature not exceed 125°C under worst case operating conditions verified in the end application.  
 3 I<sub>sat</sub>: Amps for approximately 20% rolloff (@25°C).

4 K-factor: Used to determine B<sub>p-p</sub> for core loss (see graph). B<sub>p-p</sub> = K \* L \* ΔI, B<sub>p-p</sub>: (Gauss), K: (K-factor from table), L: (inductance in µH), ΔI (peak-to-peak ripple current in amps).  
 5 Part Number Definition: HCP0703-xxx-R  
 • HCP0703 = Product code and size  
 • xxx= Inductance value in µH, R = decimal point. If no "R" is present, then third character = # of zeros  
 • "-R" suffix = RoHS compliant

### Dimensions - mm

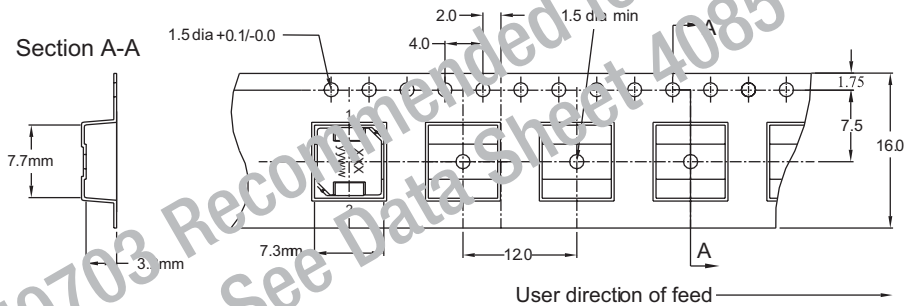


Part Marking: HCP0703

xxx = Inductance value in  $\mu\text{H}$ . (R = Decimal point). If no "R" is present, then last character is # of zeros

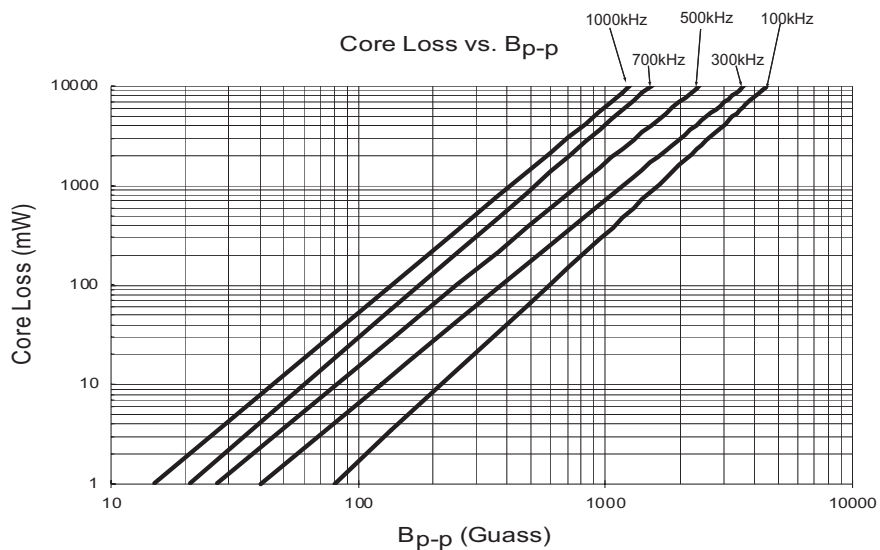
yyww = Date code

### Packaging Information - mm

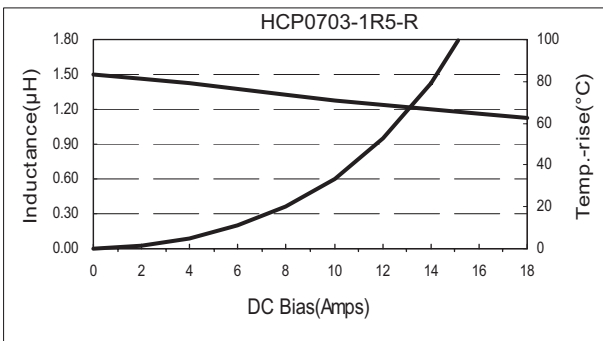
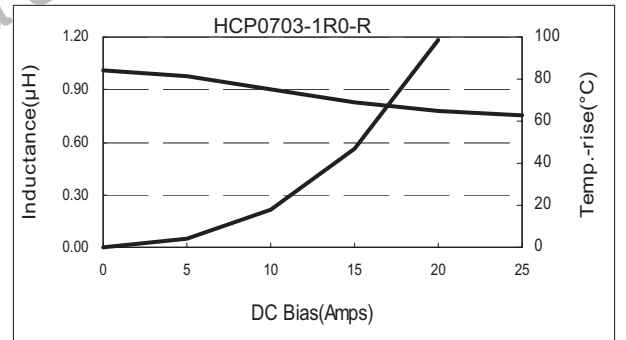
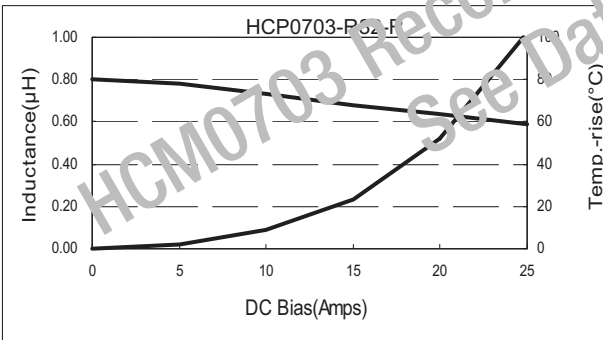
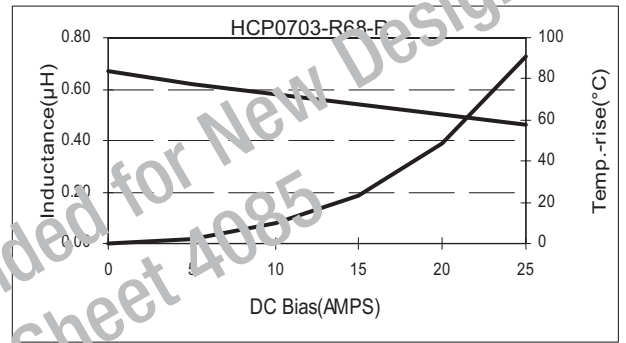
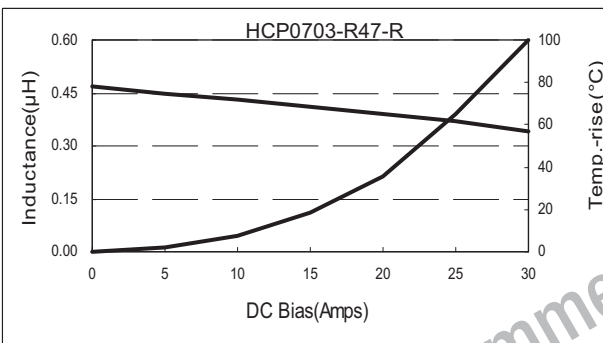
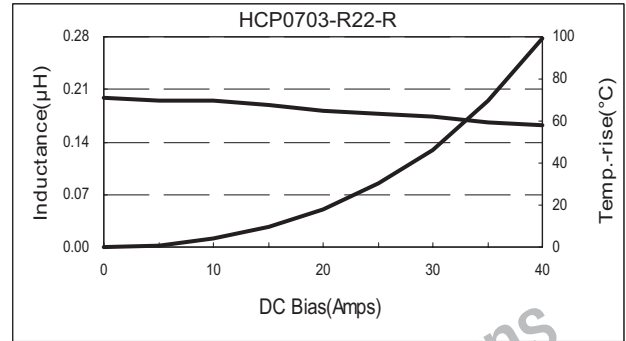
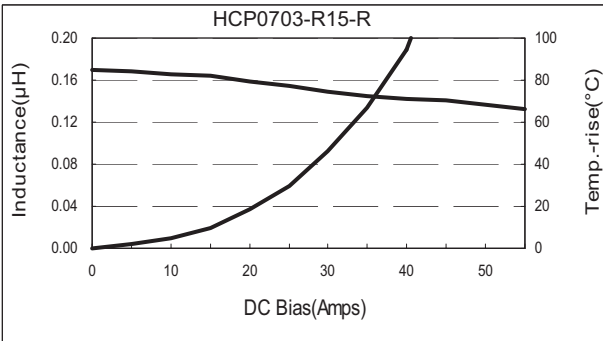


Supplied in tape and reel packaging, 1500 parts per reel, 13" diameter reel.

### Core Loss

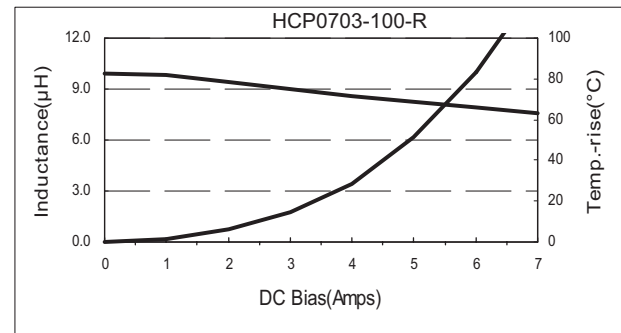
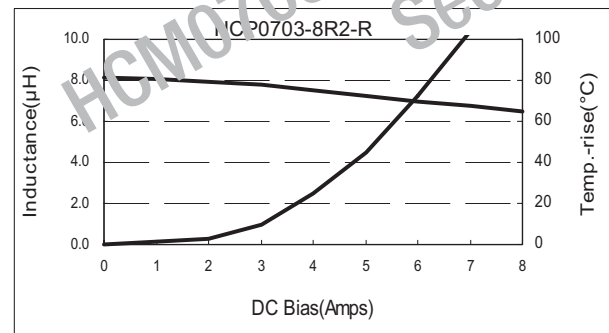
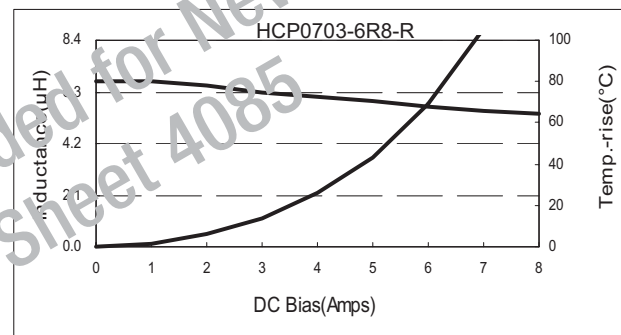
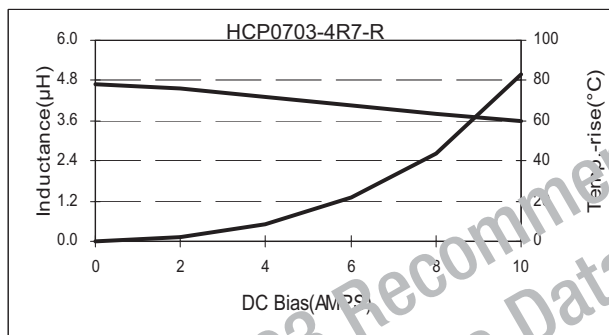
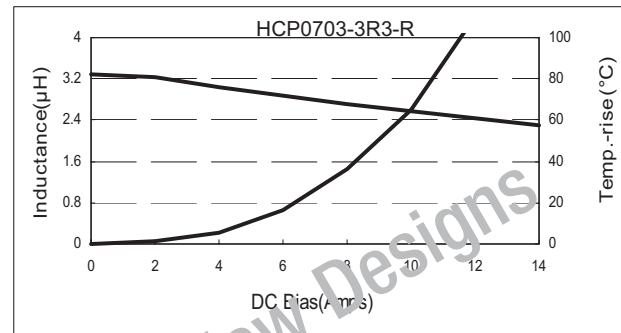
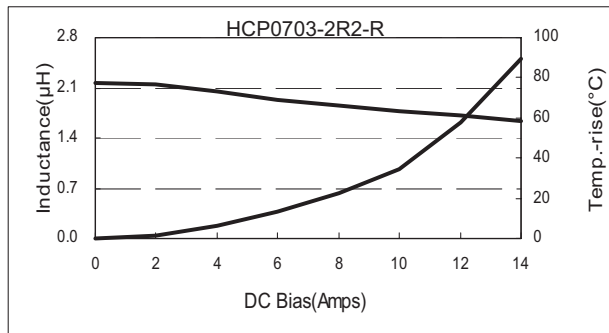


### Performance Graphs





## Performance Graphs



### North America

Cooper Electronic Technologies  
1225 Broken Sound Parkway NW  
Suite F  
Boca Raton, FL 33487-3533  
Tel: 1-561-998-4100  
Fax: 1-561-241-6640  
Toll Free: 1-888-414-2645

Cooper Bussmann  
P.O. Box 14460  
St. Louis, MO 63178-4460  
Tel: 1-636-394-2877  
Fax: 1-636-527-1607

### Europe

Cooper Electronic Technologies  
Cooper (UK) Limited  
Burton-on-the-Wolds  
Leicestershire • LE12 5TH UK  
Tel: +44 (0) 1509 882 737  
Fax: +44 (0) 1509 882 786

Cooper Electronic Technologies  
Avda. Santa Eulalia, 290  
08223  
Terrassa, (Barcelona), Spain  
Tel: +34 937 362 812  
+34 937 362 813  
Fax: +34 937 362 719

### Asia Pacific

Cooper Electronic Technologies  
1 Jalan Kilang Timor  
#06-01 Pacific Tech Centre  
Singapore 159303  
Tel: +65 278 6151  
Fax: +65 270 4160

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